TOSHIBA Digital Integrated Circuit Silicon Monolithic

TC7SPN3125CFC

Low Voltage/Low Power 1-Bit Dual Supply Bus Buffer

The TC7SPN3125 is an advanced high-speed CMOS 1-bit dual supply voltage interface bus buffer fabricated with silicon gate CMOS technology.

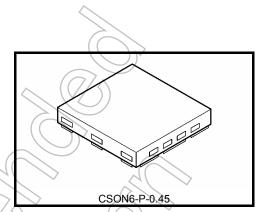
It is also designed with over voltage tolerant inputs and outputs up to $3.6\ V.$

Designed for use as an interface between a 1.2-V, 1.5-V, 1.8-V, or 2.5-V bus and a 1.8-V, 2.5-V or 3.3-V bus in mixed 1.2-V, 1.5-V, 1.8-V or 2.5-V/1.8-V, 2.5-V or 3.3-V supply systems.

The A-input interfaces with the 1.2-V, 1.5-V, 1.8-V or 2.5-V bus, the B-output with the 1.8-V, 2.5-V, 3.3-V bus.

The enable input (\overline{OE}) can be used to disable the device so that the signal lines are effectively isolated.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.



Weight: 0.002 g (typ.)

Features (Note)

- Level converter for interfacing 1.2-V to 1.8-V, 1.2-V to 2.5-V, 1.2-V to 3.3-V, 1.5-V to 2.5-V, 1.5-V to 3.3-V, 1.8-V to 2.5-V, 1.8-V to 3.3-V or 2.5 V to 3.3-V system.
- High-speed operation: $t_{pd} = 13.7 \text{ ns (max)} (V_{CCA} = 2.5 \pm 0.2 \text{ V}, V_{CCB} = 3.3 \pm 0.3 \text{ V})$

 t_{pd} = 14.8 ns (max) (V_{CCA} = 1.8 ± 0.15 V, V_{CCB} = 3.3 ± 0.3 V)

 $t_{pd} = 16.0 \text{ ns (max)} (V_{CCA} = 1.5 \pm 0.1 \text{ V}, V_{CCB} = 3.3 \pm 0.3 \text{ V})$

 t_{pd} = 29 ns (max) (V_{CCA} = 1.2 ± 0.1 V, V_{CCB} = 3.3 ± 0.3 V)

 $t_{pd} = 18.5 \text{ ns (max)} (V_{CCA} = 1.8 \pm 0.15 \text{ V}, V_{CCB} = 2.5 \pm 0.2 \text{ V})$

 $t_{pd} = 19.7 \text{ ns (max) (VCCA} = 1.5 \pm 0.1 \text{ V, VCCB} = 2.5 \pm 0.2 \text{ V)}$

 $t_{pd} = 33 \text{ ns (max)} (V_{CCA} = 1.2 \pm 0.1 \text{ V}, V_{CCB} = 2.5 \pm 0.2 \text{ V})$

 $t_{pd} = 43 \text{ ns (max)} (V_{CCA} = 1.2 \pm 0.1 \text{ V}, V_{CCB} = 1.8 \pm 0.15 \text{ V})$

• Output current : $I_{OHB} / I_{OLB} = \pm 3 \text{ mA (min)} (V_{CCB} = 3.0 \text{ V})$

 $I_{OHB} / I_{OLB} = \pm 2 \text{ mA (min)} (V_{CCB} = 2.3 \text{ V})$

 $I_{OHB} / I_{OLB} = \pm 0.5 \text{ mA (min)} (V_{CCB} = 1.65 \text{ V})$

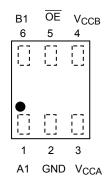
- Latch-up performance: -300 mA
- ESD performance: Machine model ≥ ±200 V

∕ Human body model ≥ ±2000 V

- Ultra-small package: CSON6(CST6C)
- Low current consumption: Using the new circuit significantly reduces current consumption when OE = "H". Suitable for battery-driven applications such as PDAs and cellular phones.
- Floating A-bus is permitted (when $\overline{OE} = \text{"H"}$)
- 3.6-V tolerant function and power-down protection provided on all inputs and outputs.

Note: Do not apply a signal to any bus pins when it is in the output mode. Damage may result.

Pin Assignment (top view)



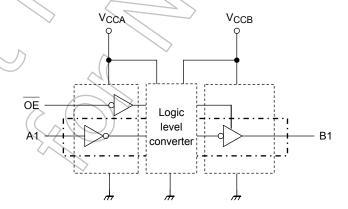
Truth Table

Inputs		Output
ŌĒ	A1	B1
L	L	L
L	Н	Н
Н	Х	Z

X: Don't care

Z: High impedance

Block Diagram



Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Power supply voltage (Note 2)	V_{CCA}	-0.5 to 4.6	V
rower supply voltage (Note 2)	V _{CCB}	-0.5 to 4.6	V
DC input voltage (A1, \overline{OE})	V_{IN}	-0.5 to 4.6	V
DC output voltage	V _{OUTB}	-0.5 to 4.6 (Note 3)	V
(B1)	VOOTB	-0.5 to V _{CCB} + 0.5 (Note 4)	(
Input diode current	I _{IK}	-25	mA
Output diode current	I _{OK}	±50 (Note 5)	mA 🦳
DC output current	I _{OUTB}	±6	mA
DC V _{CC} /ground current per supply pin	I _{CCA}	±25	mA
DC VCC/ground current per supply pin	I _{CCB}	±50	
Power dissipation	P_{D}	100 (Note 6)	mW
Storage temperature	T _{stg}	-65 to 150	>>∘C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: Don't supply a voltage to V_{CCB} pin when V_{CCA} is in the OFF state.

Note 3: Output in OFF state

Note 4: High or Low state. IOUT absolute maximum rating must be observed.

Note 5: $V_{OUT} < GND, V_{OUT} > V_{CC}$

Note 6: Mounted on an FR4 board. (25.4 mm × 25.4 mm × 1.6 mm, Cu Pad: 0.4 mm²)

Operating Ranges (Note 1)

Characteristics	Symbol	Rating		Unit
Power supply voltage	V _{CCA}	1.1 to 2.7		V
	VccB	1.65 to 3.6		V
Input voltage (A1, $\overline{\text{OE}}$)	V _{IN}	0 to 3.6		٧
Output voltage	Voutb	0 to 3.6	(Note 2)	٧
(B1)	VOOTB	0 to V _{CCB}	(Note 3)	V
Output outport		±3	(Note 4)	
Output current (B1)	IOUTB	±2	(Note 5)	mA
		±0.5	(Note 6)	
Operating temperature	T _{opr}	-40 to 85		°C
Input rise and fall time	dt/dv	0 to 10	(Note 7)	ns/V

Note 1: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V_{CC} or GND.

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Note 2: Output in OFF state

Note 3: High or low state

Note 4: $V_{CCB} = 3.0 \text{ to } 3.6 \text{ V}$

Note 5: $V_{CCB} = 2.3 \text{ to } 2.7 \text{ V}$

Note 6: $V_{CCB} = 1.65 \text{ to } 1.95 \text{ V}$

Note 7: $V_{IN} = 0.8$ to 2.0 V, $V_{CCA} = 2.5$ V, $V_{CCB} = 3.0$ V



Electrical Characteristics

DC Characteristics (1.1 V \leq V_{CCA} \leq 2.7 V, 1.65 V \leq V_{CCB} \leq 3.6 V)

						Ta = -40	to 85°C	
Characteristics	Symbol	T	est Condition	V _{CCA} (V)	V _{CCB} (V)	Min	Max	Unit
							IVIAX	
				1.1 ≤ V _{CCA} <1.4	1.65 to 3.6	0.65× V _{CCA}	_	
H-level input voltage	V _{IHA}	A1, ŌE		1.4 ≤ V _{CCA} <1.65	1.65 to 3.6	0.65× VCCA	_	V
				1.65 ≤ V _{CCA} <2.3	2.3 to 3.6	0.65× V _{CCA}	_	
				$2.3 \le V_{CCA} < 2.7$	2.7 to 3.6	1.6	_	
				1.1 ≤ V _{CCA} <1.4	1.65 to 3.6	_	0.30× V _{CCA}	
L-level input voltage	V_{ILA}	A1, ŌE		1.4 ≤ V _{CCA} <1.65	1.65 to 3.6		0.30× V _{CCA}	V
				1.65 ≤ V _{CCA} <2.3	2.3 to 3.6		0.35× V _{CCA}	
				2.3 ≤ V _{CCA} <2.7	2.7 to 3.6		0.7	
			I _{OHB} = -100 μA	1.1 to 2.7	1.65 to 3.6	V _{CCB} - 0.2	_	
H-level output voltage	V _{OHB}	A1 = V _{IH}	$I_{OHB} = -0.5 \text{ mA}$	1.1 to 1.65	1.65	1.25		V
,			I _{OHB} = -2 mA	1.1 to 2.3	2.3	1.7	_	
			I _{OHB} = -3 mA	1.1 to 2.7	3.0	2.2	_	
			I _{OLB} = 100 μA	1.1 to 2.7	1.65 to 3.6	_	0.2	
l level system to reliance			$I_{OLB} = 0.5 \text{ mA}$	1.1 to 1.65	1.65	_	0.3	
L-level output voltage	V_{OLB}	$A1 = V_{IL}$	I _{OLB} = 2 mA	1.1 to 2.3	2.3	_	0.6	V
			I _{OLB} = 3 mA	1.1 to 2.7	3.0	_	0.55	
3-state output OFF state current	I _{OZB}	A1 = V _{IHA} B1 = 0 to 3		1.1 to 2.7	1.65 to 3.6	_	±2.0	μА
Input leakage current	In	$V_{IN} = 0$ to	3.6 V	1.1 to 2.7	1.65 to 3.6	_	±1.0	μΑ
	loff1	V _{IN} , B1 = 0	0 to 3.6 V	0	0	_	2.0	
Power-off leakage current	l _{OFF2}	OE = V _{CC}	A	1.1 to 2.7	0	_	2.0	μА
	I _{OFF3}	A1, B1 = 0	to 3.6 V	1.1 to 2.7	Open	_	2.0	
$\langle \gamma \rangle$	I _{CCA}	$V_{IN} = V_{CC}$	A or GND	1.1 to 2.7	1.65 to 3.6	_	2.0	
	І ссв	V _{IN} = V _C ¢	or GND	1.1 to 2.7	1.65 to 3.6	_	2.0	
Quiescent supply current	ICCA	V _{CCA} < V _I	N ≤ 3.6 V	1.1 to 2.7	1.65 to 3.6	_	±2.0	μА
	ICCB	$V_{IN} = V_{CC}$ $V_{CCB} \le B$		1.1 to 2.7	1.65 to 3.6	_	±2.0	
			7					

AC Characteristics (Ta = -40 to 85° C, Input: $t_r = t_f = 2.0$ ns)

$\mbox{VCCA} = 2.5 \pm 0.2 \mbox{ V}, \mbox{VCCB} = 3.3 \pm 0.3 \mbox{ V}$

Characteristics	Symbol	Test Condition	Min	Max	Unit
Propagation delay time	t _{pLH}	Figure 1, Figure 2	1:0	13.7	
(A1 → B1)	t_{pHL}	Figure 1, Figure 2	1.0	13.7	
3-state output enable time	t_{pZL}	Figure 1 Figure 3	1.0	16.6	ns
$(\overline{OE} \to B1)$	t _{pZH}	Figure 1, Figure 3	1.0		113
3-state output disable time	t_{pLZ}	Figure 1, Figure 3	77	7.2	
$(\overline{OE} \to B1)$	t _{pHZ}	rigure 1, rigure 3	1.0) 1.2	

$V_{CCA} = 1.8 \pm 0.15$ V, $V_{CCB} = 3.3 \pm 0.3$ V

Characteristics	Symbol	Test Condition	Min	Max Unit
Propagation delay time	t _{pLH}	Figure 1, Figure 2	1.0	14.8
$(A1 \rightarrow B1)$	t_{pHL}	Figure 1, Figure 2	1.0	(40)
3-state output enable time	t _{pZL}	Figure 1, Figure 3	10	18 9 ns
$(\overline{OE} \rightarrow B1)$	t _{pZH}	rigule 1, rigule 3	1.0	18.9 ns
3-state output disable time	t _{pLZ}	Figure 1, Figure 3	10	8.7
$(\overline{OE} \to B1)$	t _{pHZ}	rigule 1, rigule 3	1.0	0.1

$V_{CCA} = 1.5 \pm 0.1 \text{ V}, V_{CCB} = 3.3 \pm 0.3 \text{ V}$

Characteristics	Symbol	Test Condition	Min	Max	Unit
Propagation delay time $(A1 \rightarrow B1)$	t _{рЬН}	Figure 1, Figure 2	1.0	16.0	
3-state output enable time (OE → B1)	t _{pZL}	Figure 1, Figure 3	1.0	22.8	ns
3-state output disable time (OE → B1)	t _{pLZ}	Figure 1, Figure 3	1.0	10.2	

$V_{CCA} = 1.2 \pm 0.1 \text{ V}, V_{CCB} = 3.3 \pm 0.3 \text{ V}$

Characteristics	Symbol	Test Condition	Min	Max	Unit
Propagation delay time (A1 → B1)	t _{pLH}	Figure 1, Figure 2	1.0	29	
3-state output enable time (OF → B1)	t _{pZL}	Figure 1, Figure 3	1.0	63	ns
3-state output disable time $(\overline{OE} \rightarrow B1)$	t _{pLZ} t _{pHZ}	Figure 1, Figure 3	1.0	23	

$V_{CCA} = 1.8 \pm 0.15 \ V, \ V_{CCB} = 2.5 \pm 0.2 \ V$

Characteristics	Symbol	Test Condition	Min	Max	Unit
Propagation delay time	t _{pLH}	Figure 1 Figure 2	1.0	18.5	
$(A1 \rightarrow B1)$	t _{pHL}	Figure 1, Figure 2	1.0	10.5	
3-state output enable time	t _{pZL}	Figure 1 Figure 2	1.0	23.6	ns
$(\overline{OE} \to B1)$	t _{pZH}	Figure 1, Figure 3	1.0	23.0	113
3-state output disable time	t _{pLZ}	Figure 1 Figure 3	1.0	6.9	
$(\overline{OE} \to B1)$	t _{pHZ}	Figure 1, Figure 3		0.9	

$V_{\mbox{\footnotesize CCA}} = 1.5 \pm 0.1 \mbox{ V}, \mbox{\footnotesize V}_{\mbox{\footnotesize CCB}} = 2.5 \pm 0.2 \mbox{\footnotesize V}$

Characteristics	Symbol	Test Condition	Min	Max Unit
Propagation delay time	t _{pLH}	Figure 1, Figure 2	1.0	19.7
(A1 → B1)	t_{pHL}	Figure 1, Figure 2	1.0	19.7
3-state output enable time	t _{pZL}	Figure 1 Figure 2	<u> </u>	26-6 ns
$(\overline{OE} \to B1)$	t _{pZH}	Figure 1, Figure 3	7.0	26.6 ns
3-state output disable time	t _{pLZ}	Figure 1, Figure 3	1.0	8.3
$(\overline{OE} \rightarrow B1)$	t_{pHZ}	i igure 1,1 igure 3	(1.0)	0.3

$V_{CCA} = 1.2 \pm 0.1 \text{ V, } V_{CCB} = 2.5 \pm 0.2 \text{ V}$

Characteristics	Symbol	Test Condition	Min	Max	Unit
Propagation delay time $(A1 \rightarrow B1)$	t _p LH t _p HL	Figure 1, Figure 2	1.0	33	
3-state output enable time $(\overline{OE} \rightarrow B1)$	t _p ZL t _p ZH	Figure 1, Figure 3	1.0	66	ns
3-state output disable time (OE → B1)	t _{pLZ}	Figure 1, Figure 3	1.0	20	

$V_{CCA} = 1.2 \pm 0.1 \text{ V}, V_{CCB} = 1.8 \pm 0.15 \text{ V}$

Characteristics	Symbol	Test Condition	Min	Max	Unit
Propagation delay time (A1 → B1)	t _{pLH}	Figure 1, Figure 2	1.0	43	
3-state output enable time (OE → B1)	t _p zL t _p zH	Figure 1, Figure 3	1.0	78	ns
3-state output disable time (OE → B1)	t _{pLZ}	Figure 1, Figure 3	1.0	20	

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Capacitive Characteristics (Ta=25°C)

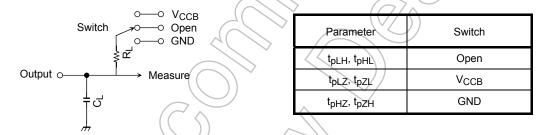
Characteristics		Symbol	Test Condition			Tun	Unit
			rest condition	V _{CCA} (V)	V _{CCB} (V)	Тур.	Offic
Input capacitance		C _{IN}	OE, A1	2.5	3.3	7	pF
Output capacitance		C _{OUT}	B1	2.5	3.3	8	pF
		C _{PDA}	OE ="L"	2.5	3.3	3	- pF
Power dissipation capacitance			OE ="H"	2.5	3.3	0	
	(Note)	C _{PDB}	OE ="L"	2.5	3.3	13	
			OE ="H"	2,5	3.3	0	

Note: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/2 \text{ (per bit)}$

AC Test Circuit



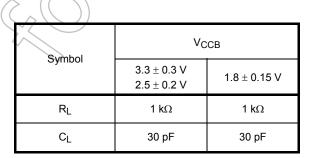


Figure 1

AC Waveform

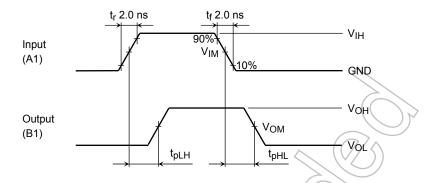


Figure 2 t_{pLH}, t_{pHL}

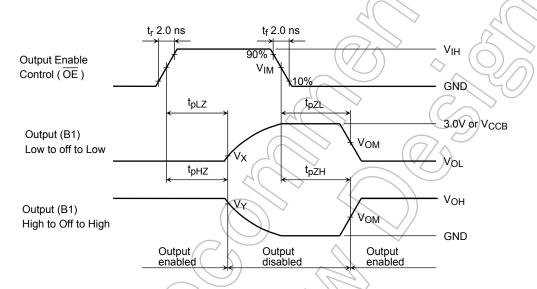


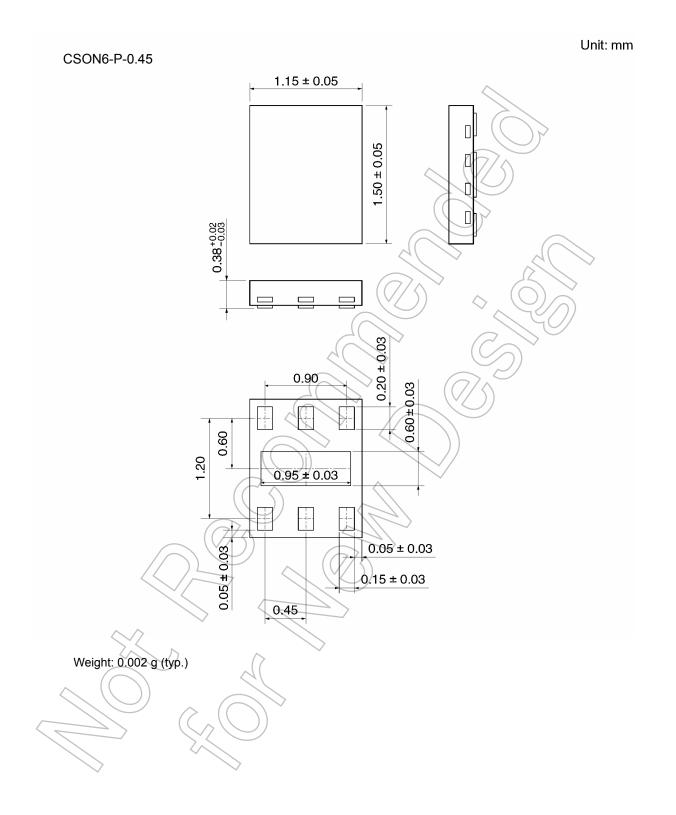
Figure 3 t_{pLZ}, t_{pHZ}, t_{pZL}, t_{pZH}

	/ /	 	Vcca, Vccb						
1	///	Symbol	23+031/	$2.5\pm0.2\mathrm{V}$	$1.5\pm0.1~\textrm{V}$				
		>	$3.3 \pm 0.3 \text{ V}$	1.8 ± 0.15 V	$1.2\pm0.1~\textrm{V}$				
	Input	V _{IH}	1	V _{CCA}	V _{CCA}				
/	5	V _{IM}		V _{CCA} / 2	V _{CCA} / 2				
\	Output	V _{OM} <	V _{OH} / 2	V _{OH} / 2	-				
	^	Уx	V _{OL} + 0.3 V	V _{OL} + 0.15 V	-				
		> VY	V _{OH} – 0.3 V	V _{OH} – 0.15 V	-				

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2014-03-01

Package Dimensions



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